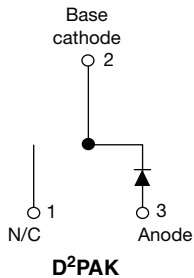
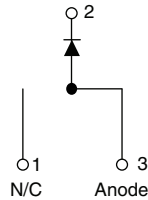


**Ultrafast Rectifier, 30 A FRED Pt®**

**VS-ETU3006SHM3**

**D²PAK**

**VS-ETU3006-1HM3**

**TO-262**
**FEATURES**

- Low forward voltage drop
- Ultrafast recovery time
- 175 °C operating junction temperature
- Low leakage current
- AEC-Q101 qualified, meets JESD 201 class 1A whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**DESCRIPTION/APPLICATIONS**

Ultralow  $V_F$ , soft-switching ultrafast rectifiers optimized for Discontinuous (Critical) Mode (DCM) Power Factor Correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

**APPLICATIONS**

AC/DC SMPS 70 W to 400 W

e.g. laptop and printer AC adaptors, desktop PC, TV and monitor, games units, and DVD AC/DC power supplies.

**PRODUCT SUMMARY**

Package	TO-263AB (D²PAK), TO-262AA
$I_{F(AV)}$	30 A
$V_R$	600 V
$V_F$ at $I_F$	2 V
$t_{rr}$ (typ.)	30 ns
$T_J$ max.	175 °C
Diode variation	Single die

**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Repetitive peak reverse voltage	$V_{RRM}$		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 113\text{ °C}$	30	A
Non-repetitive peak surge current	$I_{FSM}$	$T_C = 25\text{ °C}$	200	
Operating junction and storage temperatures	$T_J, T_{Stg}$		-65 to 175	°C

**ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$  unless otherwise specified)**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100\ \mu\text{A}$	600	-	-	V
		$I_F = 30\text{ A}$	-	1.4	2.0	
Forward voltage	$V_F$	$I_F = 30\text{ A}, T_J = 150\text{ °C}$	-	1.15	1.35	μA
		$V_R = V_R$ rated	-	0.02	30	
Reverse leakage current	$I_R$	$T_J = 150\text{ °C}, V_R = V_R$ rated	-	30	250	pF
		$V_R = 600\text{ V}$	-	20	-	
Junction capacitance	$C_T$	$V_R = 600\text{ V}$	-	20	-	nH
Series inductance	$L_S$	Measured lead to lead 5 mm from package body	-	8.0	-	nH



DYNAMIC RECOVERY CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1\text{ A}$ , $di_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$		-	30	45	ns
		$T_J = 25\text{ }^\circ\text{C}$	$I_F = 30\text{ A}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 200\text{ V}$	-	45	-	
		$T_J = 125\text{ }^\circ\text{C}$		-	100	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	$I_F = 30\text{ A}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 200\text{ V}$	-	5.6	-	A
		$T_J = 125\text{ }^\circ\text{C}$		-	10	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^\circ\text{C}$	$I_F = 30\text{ A}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 200\text{ V}$	-	127	-	nC
		$T_J = 125\text{ }^\circ\text{C}$		-	580	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$		- 65	-	175	$^\circ\text{C}$
Thermal resistance, junction to case	$R_{thJC}$		-	0.95	1.4	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient	$R_{thJA}$	Typical socket mount	-	-	70	
Thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, flat, smooth and greased	-	0.5	-	
Weight			-	2.0	-	g
			-	0.07	-	oz.
Mounting torque			6 (5)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style D <sup>2</sup> PAK modified	ETU3006SH			
		Case style TO-262	ETU3006-1H			

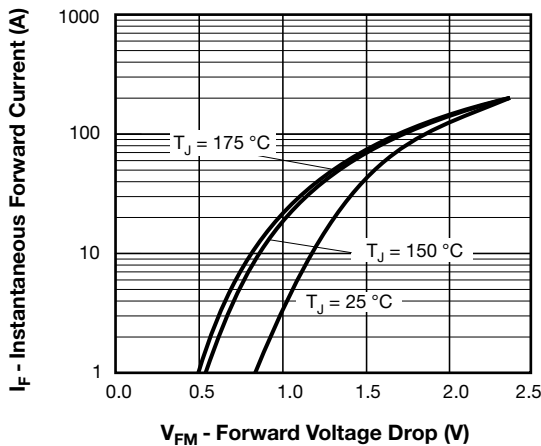


Fig. 1 - Typical Forward Voltage Drop Characteristics

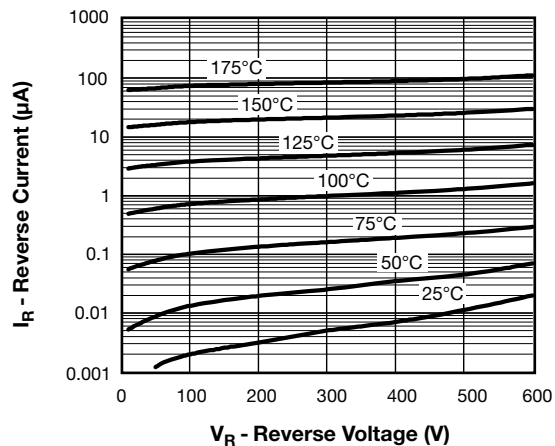


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

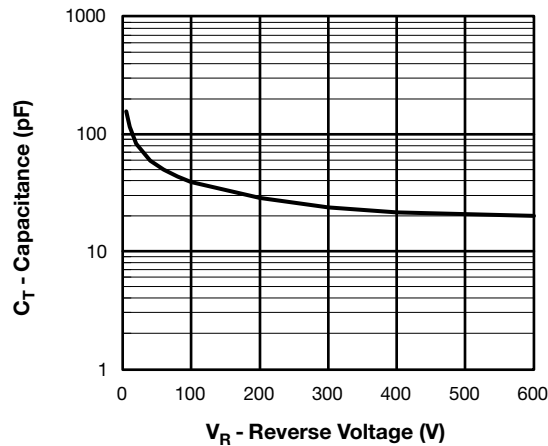


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

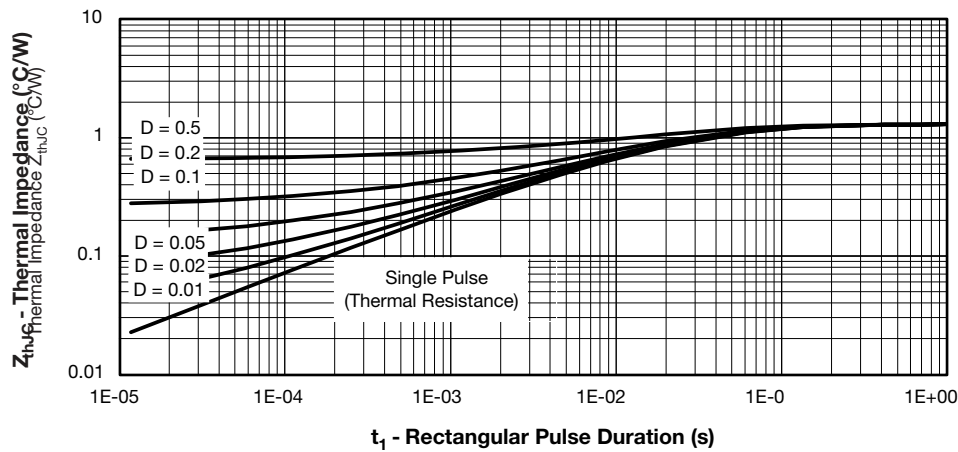


Fig. 4 - Max. Thermal Impedance  $Z_{thJC}$  Characteristics

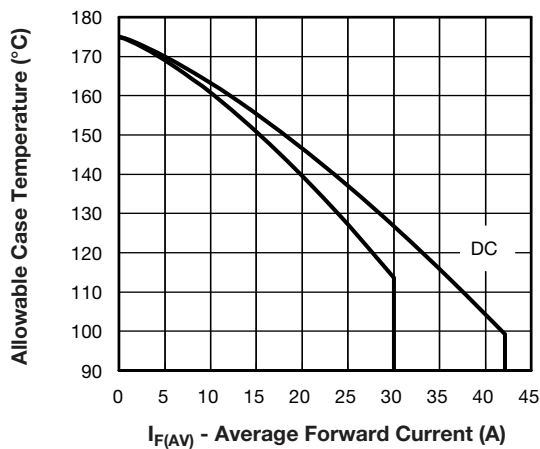


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

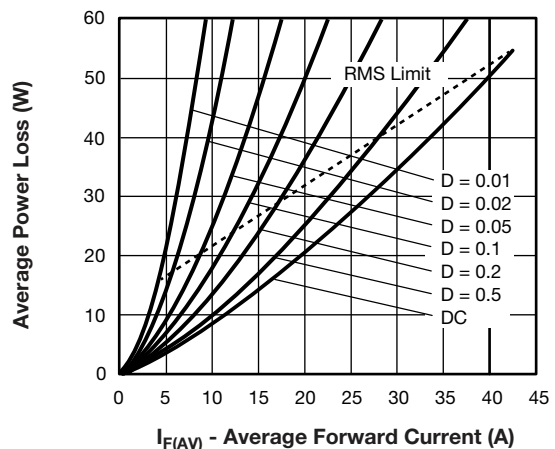


Fig. 6 - Forward Power Loss Characteristics

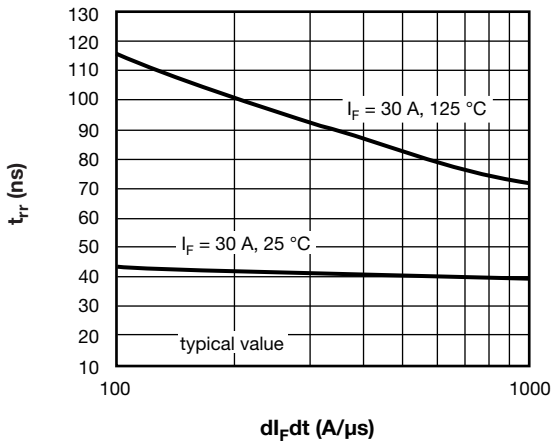


Fig. 7 - Typical Reverse Recovery vs.  $dI_F/dt$

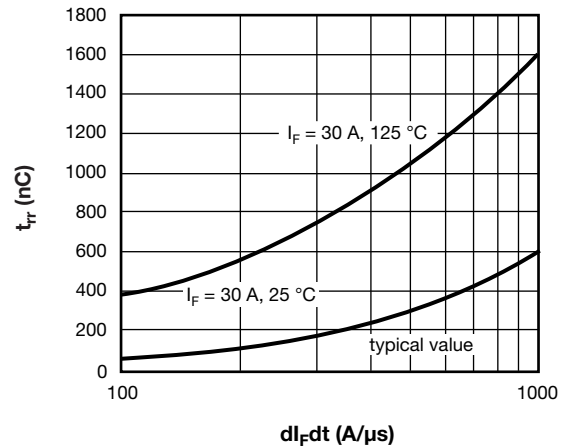


Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$

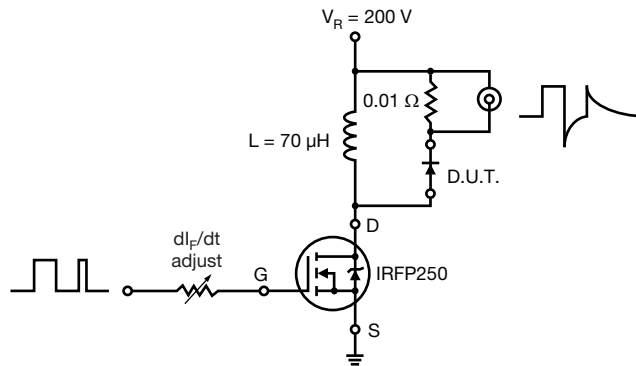
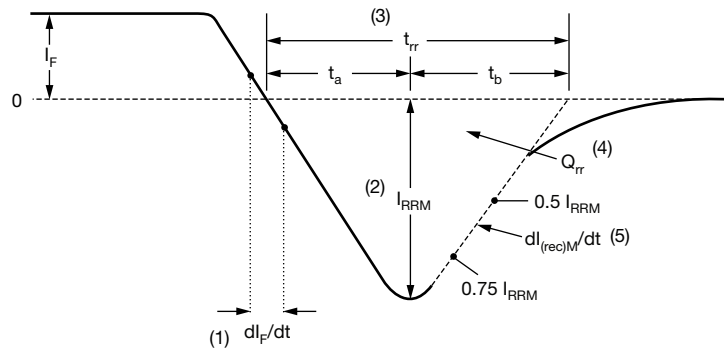


Fig. 9 - Reverse Recovery Parameter Test Circuit



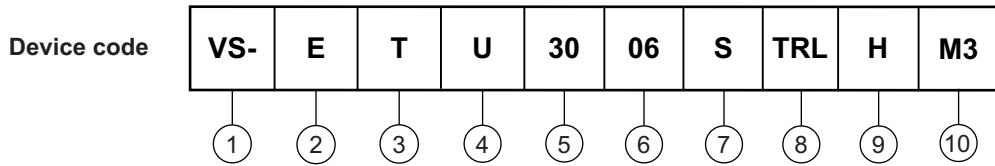
- (1)  $dI_F/dt$  - rate of change of current through zero crossing
- (2)  $I_{RRM}$  - peak reverse recovery current
- (3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.
- (4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$
- (5)  $dI_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

Fig. 10 - Reverse Recovery Waveform and Definitions



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Circuit configuration  
E = Single diode
- 3** - T = TO-220
- 4** - U = Ultrafast recovery time
- 5** - Current code (30 = 30 A)
- 6** - Voltage code (06 = 600 V)
- 7** - • S = D<sup>2</sup>PAK  
• -1 = TO-262
- 8** - • None = Tube  
• TRL = Tape and reel (left oriented, for D<sup>2</sup>PAK package)  
• TRR = Tape and reel (right oriented, for D<sup>2</sup>PAK package)
- 9** - H = AEC-Q101 qualified
- 10** - Environmental digit:  
-M3 = Halogen-free, RoHS compliant, and terminations lead (Pb)-free

<b>ORDERING INFORMATION</b> (Example)			
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-ETU3006SHM3	50	1000	Antistatic plastic tube
VS-ETU3006-1HM3	50	1000	Antistatic plastic tube
VS-ETU3006STRRHM3	800	800	13" diameter reel
VS-ETU3006STRLHM3	800	800	13" diameter reel

<b>LINKS TO RELATED DOCUMENTS</b>		
Dimensions	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a>
Part marking information	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95444">www.vishay.com/doc?95444</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95443">www.vishay.com/doc?95443</a>
Packaging information	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>



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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

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